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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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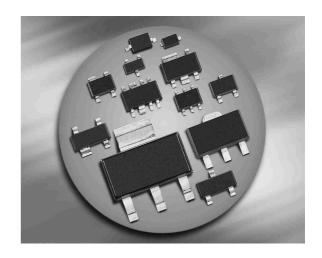




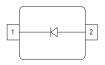
Silicon Variable Capacitance Diode

- For VHF tuned circuit applications
- High figure of merit
- Pb-free (RoHS compliant) package





BB439



Туре	Package	Configuration	L S(nH)	Marking
BB439	SOD323	single	1.8	white 2

Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_{R}	28	V
Peak reverse voltage	V_{RM}	30	
($R \ge 5 \mathrm{k}\Omega$)			
Forward current	I _F	20	mA
Operating temperature range	T_{op}	-55 125	°C
Storage temperature	$T_{ m stg}$	-55 150	

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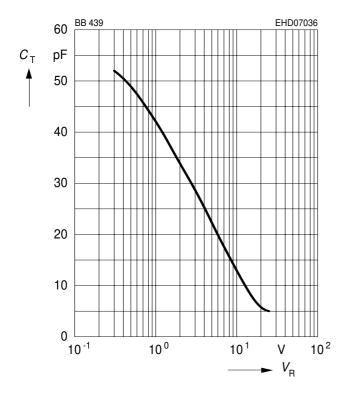
Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol		Values		
		min.	typ.	max.	
DC Characteristics	·	•			
Reverse current	I_{R}				nA
V _R = 28 V		_	-	20	
V_{R} = 28 V, T_{A} = 85 °C		-	-	200	
AC Characteristics					
Diode capacitance	C_{T}				pF
$V_{R} = 1 \text{ V}, f = 1 \text{ MHz}$		-	43	_	
$V_{R} = 2 \text{ V}, f = 1 \text{ MHz}$		31.5	34.5	37.5	
$V_{R} = 3 \text{ V}, f = 1 \text{ MHz}$		26.5	29	31.5	
$V_{R} = 25 \text{ V}, f = 1 \text{ MHz}$		4.3	5.1	6	
Capacitance ratio	C _{T2} /C _{T25}	6	6.9	8]
V_{R} = 2 V, V_{R} = 25 V, f = 1 MHz					
Capacitance ratio	C _{T3} /C _{T25}	5	5.8	6.5	
$V_{R} = 3 \text{ V}, V_{R} = 25 \text{ V}, f = 1 \text{ MHz}$					
Capacitance matching ¹⁾	$\Delta C_{T}/C_{T}$	-	-	3	%
$V_{R} = 3 \text{ V}, V_{R} = 25 \text{ V}, f = 1 \text{ MHz}$					
Series resistance	r _S	-	0.35	0.5	Ω
V_{R} = 10 V, f = 100 MHz					
Figure of merit	Q				
$V_{R} = 3 \text{ V}, f = 50 \text{ MHz}$		-	280	-	
V_{R} = 25 V, f = 200 MHz		-	600	_	

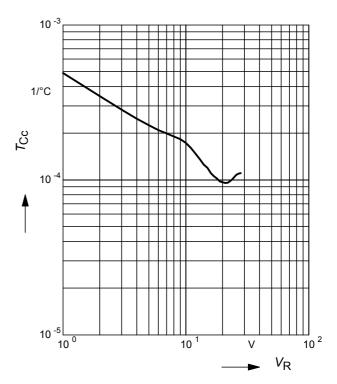
¹For details please refer to Application Note 047.



Diode capacitance $C_T = f(V_R)$ f = 1MHz



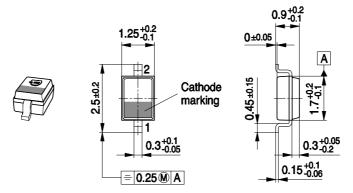
Temperature coefficient of the diode capacitance $T_{Cc} = f(V_R)$



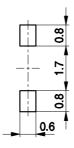
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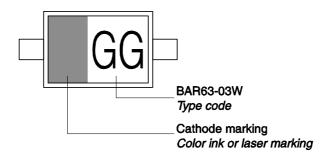
Package Outline



Foot Print

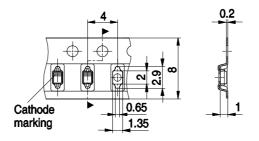


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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